

**BM81SPK02NB6**

**Bluetooth 3.0 EDR Wireless Speaker Module**

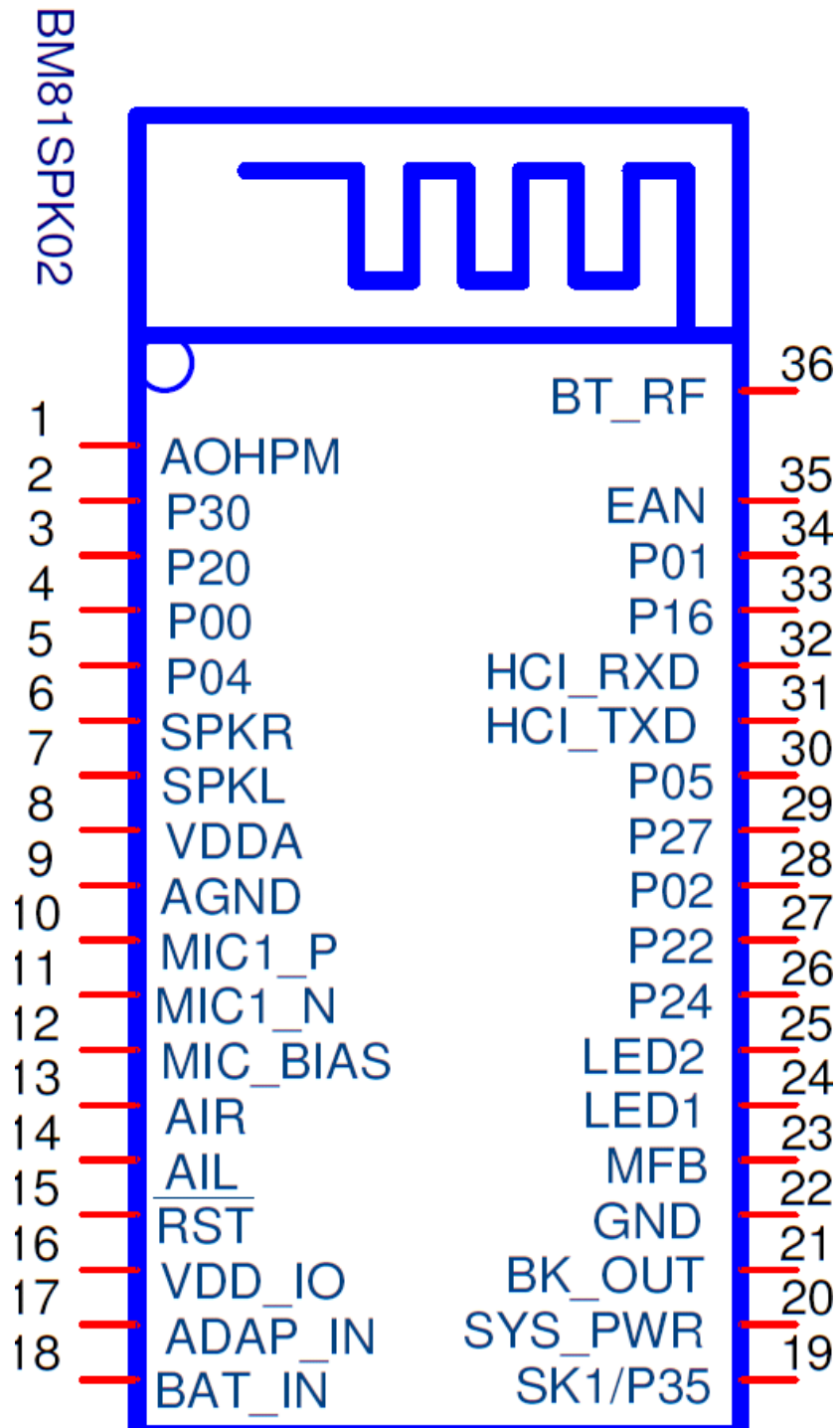
## Product Description

The ISSC BM81SPK02 is a highly integrated Bluetooth 3.0 EDR stereo module, designed for high data rate, short-range wireless communication in the 2.4 GHz ISM band. With the ISSC Bluetooth stack and profile, the ISSC BM81SPK02 provides a low power and ultra-low cost Bluetooth 3.0+EDR solution for wireless voice/audio applications.

## Features

- Main Chip: ISSC IS1681S
- Bluetooth 3.0 EDR compliant
- Max. +4dBm Class 2 output power
- Receiver Sensitivity: GFSK typical -90dBm,  $\pi/4$  PSK typical -91dBm, 8DPSK typical -83dBm
- Piconet and Scatter net support
- HCI UART interface
- CVSD, A-law,  $\mu$ -law CODEC algorithms for voice applications
- SBC decode for Bluetooth audio streaming
- Build-in High performance stereo audio codec
- Microphone input and audio line-in support
- Build-in audio mux/gain control for line-in audio signal
- Cap-less/single end headphone driver
- Audio DAC: 94dB SNR
- Build in Max. 350mAH Li-ion battery charger
- HSP, HFP, A2DP, AVRCP profile support
- 3.3V operating voltage
- ROM version: 32Kb EEPROM
- 35 pins for DIP module, 36pins for SMT module (with additional 36th pin antenna port for external antenna option)
- Size: 15mm x29mm
- Build-in PCB Antenna
- RoHS compliant

**Device Pinout Diagram**



## Pin Definition

Pin No.	I/O	Name	Description
1	AP	AOHPM	Headphone common mode output/sense input. Cap-less application only.
2	P	P30	GPIO, default pull-high input Line-in detection, 1: no line-in detected; 0: line-in detected
3	I/O	P20	GPIO, default pull-high input System Configuration, H: Application L: Baseband(IBDK Mode)
4	I/O	P00	GPIO, default pull-low input. Slide Switch Detector
5	I/O	P04	GPIO, default pull-high input Audio AMP Enable
6	AO	SPKR	R-channel analog headphone output, for cap-less and single-ended applications both
7	AO	SPKL	L-channel analog headphone output, for cap-less and single-ended application both
8	AP	VDDA	Reserve for external cap to fine tune audio frequency response
9	AP	AGND	Audio ground
10	AI	MIC1_P	Mic 1 mono differential analog positive input
11	AI	MIC1_N	Mic 1 mono differential analog negative input
12	AP	MIC_BIAS	Microphone biasing voltage
13	AI	AIR	Stereo analog line in, R-channel
14	AI	AIL	Stereo analog line in, L-channel
15	I/O	RST_N	System Reset Pin
16	P	VDDIO	VDDIO pin, for calibration only Do not add external power to this pin
17	P	ADAP_IN	Power adaptor input
18	P	BAT_IN	Battery input
19	I/O	SK1/P35	Default SAR input for battery detection This pin can be re-defined as GPIO P35
20	P	SYS_PW	System Power Output
21	P	BK_OUT	Buck feedback sense pin

22	P	GND	Digital ground
23	P	MFB	Multi-Function Push Button key Combined Play/Pause key when A2DP enabled.
24	P	LED1	LED Driver 1
25	P	LED2	LED Driver 2
26	I/O	P24	GPIO, default pull-high input System Configuration, H: Boot Mode
27	I/O	P22	GPIO, default pull-low input. External LDO enable
28	I/O	P02	GPIO, default pull-high input PLAY/PAUSE button
29	I/O	P27	GPIO, default pull-high input Foward button
30	I/O	P05	GPIO, default pull-high input REW button
31	O	HCI_TXD	HCI TX data
32	I	HXI_RXD	HCI RX data
33	I/O	P16	GPIO, default pull-high input Volumn down button
34	I/O	P01	GPIO, default pull-high input Volumn up button
35	I	EAN	Embedded ROM/External Flash enable H: Embedded; L: External Flash
36	AIO	BT_RF	NC for on board PCB antenna Antenna matching if an external antenna is used

## Electrical Characteristics

### Absolute Maximum Ratings

Rating		Min	Max	Max
Operation Temperature		-40°C	+85°C	°C
Core supply voltage	VDD_CORE, VCC_RF, AVDD_SAR, AVDD_PLL	1.7V	1.98V	V
Codec supply voltage	VDD_AUDIO		3	V
I/O voltage	VDD_IO		3.3	V
Supply voltage	BK_VDD		4.3	V
	3V1_VIN		5	V
	BAT_IN		4.3	V
	ADAP_IN		7.7	V
	LED[1:0]		5	V
	Power switch		5	V

### Recommended Operate Condition

Symbol	Parameter	Min	Typical	Max	Unit
V <sub>DD18</sub>	Digital core supply voltage				
	SAR ADC supply voltage	1.8	1.85	1.95	V
	CODEC supply voltage				
V <sub>DDIO</sub>	I/O supply voltage	2.8	3	3.3	V
T <sub>OPERATION</sub>	Operating temperature range	-20	+25	+70	°C
T <sub>stg</sub>	Storage temperature	-40		+125	°C
V <sub>LDO</sub>	LDO supply voltage	1.8		3.3	V
V <sub>BAT_IN</sub>	Input voltage for SAR ADC	0.9		3.3	V

## Radio Characteristics: Transmitter section for BDR

VCC_RF = 1.85V Temperature = 25°C		Min	Typ	Max	Bluetooth specification	Unit
Maximum RF transmit power			3	4.0	-6 to 4	dBm
RF power variation over temperature range with compensation enabled			±2			dB
RF power control range			20		≥16	dB
RF power range control resolution			0.5			dB
20dB bandwidth for modulated carrier			900		≤1000	KHz
ACP  Note: F <sub>0</sub> =2441MHz	F = F <sub>0</sub> ±2MHz		-28		≤-20	dBm
	F = F <sub>0</sub> ±3MHz		-46		≤-40	dBm
	F = F <sub>0</sub> ±>3MHz		-54		≤-40	dBm
Δf <sub>1avg</sub> maximum modulation		150		165	140<Δf <sub>1avg</sub> <175	KHz
Δf <sub>2max</sub> maximum modulation		140		150	≥115	KHz
Δf <sub>2avg</sub> /Δf <sub>1avg</sub>		0.95	1		≥0.80	
ICFT (abs)		0	5	10	75	KHz
Drift rate (abs)		2		7	≤20	KHz/50μs
Drift (single slot packet, abs)			12		≤25	KHz
2 <sup>nd</sup> harmonic content @ Tx= 4dBm			-53		≤-47	dBm
3 <sup>rd</sup> harmonic content @ Tx= 4dBm			-55		≤-47	dBm

## Receiver section for BDR

Temperature = 25°C	Frequency (GHz)	Min	Typ	Max	Bluetooth specification	Unit
Sensitivity at 0.1% BER for all basic rate packet types	2.402		-90		≤-70	dBm
	2.441		-90			
	2.480		-90			
Maximum received signal at 0.1% BER			-10		≥-20	dBm
C/I co-channel			5		≤11	dB
Adjacent channel selectivity C/I  Note: F <sub>0</sub> =2441MHz	F = F <sub>0</sub> +1MHz		-7		≤0	dB
	F = F <sub>0</sub> -1MHz		-7		≤0	dB
	F = F <sub>0</sub> +2MHz		-36		≤-30	dB
	F = F <sub>0</sub> -2MHz		-22		≤-9	dB
	F = F <sub>0</sub> -3MHz		-24		≤-20	dB
	F = F <sub>0</sub> +5MHz		-50		≤-40	dB
	F = F <sub>image</sub>		-22		≤-9	dB
Maximum level of intermodulation interferers			-38		≥-39	dB



## Transmitter Section for EDR

Temperature = 25°C		Min	Typ	Max	Bluetooth specification	Unit
Relative transmit power			-1.6		-4 to 1	dB
π/4 DQPSK max carrier frequency stability	$ \omega_o $ freq. error		5		≤10 for all blocks	KHz
	$ \omega_i $ initial freq. error		10		≤75 for all blocks	KHz
	$ \omega_o+\omega_i $ block freq. error		10		≤75 for all blocks	KHz
8DPSK max carrier frequency stability	$ \omega_o $ freq. error		5		≤10 for all blocks	KHz
	$ \omega_i $ initial freq. error		10		≤75 for all blocks	KHz
	$ \omega_o+\omega_i $ block freq. error		10		≤75 for all blocks	KHz
π/4 DQPSK modulation accuracy @ Tx= 2dBm	RMS DEVM		7		≤20	%
	99% DEVM		Pass		≤30	%
	Peak DEVM			25	≤35	%
8DQPSK modulation accuracy @ Tx= 2dBm	RMS DEVM		7		≤13	%
	99% DEVM		Pass		≤20	%
	Peak DEVM			20	≤25	%

In-band spurious emissions  Note: $F_0=2441\text{MHz}$	$F > F_0+3\text{MHz}$		<-54		$\leq -40$	dBm
	$F = F_0-3\text{MHz}$		-46		$\leq -40$	dBm
	$F = F_0-2\text{MHz}$		-28		$\leq -20$	dBm
	$F = F_0-1\text{MHz}$		-30		$\leq -26$	dBm
	$F = F_0+1\text{MHz}$		-30		$\leq -26$	dBm
	$F = F_0+2\text{MHz}$		-28		$\leq -20$	dBm
	$F = F_0+3\text{MHz}$		-46		$\leq -40$	dBm
EDR differential phase encoding			100		$\geq 99$	%

## Receiver Section for EDR

Temperature = 25°C	Frequency (GHz)	Modulation	Min	Typ	Max	Bluetooth specification	Unit	
Sensitivity at 0.01% BER	2.402	$\pi/4$ DQPSK		-91		$\leq -70$	dBm	
	2.441	$\pi/4$ DQPSK		-91				
	2.480	$\pi/4$ DQPSK		-91				
	2.402	8DPSK		-83		$\leq -70$	dBm	
	2.441	8DPSK		-83				
	2.480	8DPSK		-83				
Maximum received signal at 0.1% BER		$\pi/4$ DQPSK		-10		$\geq -20$	dBm	
		8DPSK		-10		$\geq -20$		
C/I co-channel at 0.1% BER		$\pi/4$ DQPSK		4		$\leq 13$	dB	
		8DPSK		5		$\leq 21$	dB	
Adjacent channel selectivity C/I	$F = F_0 + 1\text{MHz}$	$\pi/4$ DQPSK		-14		$\leq 0$	dB	
		8DPSK		-8		$\leq 5$	dB	
	$F = F_0 - 1\text{MHz}$	$\pi/4$ DQPSK		-13		$\leq 0$	dB	
		8DPSK		-8		$\leq 5$	dB	
	Note: $F_0 = 2441\text{MHz}$	$F = F_0 + 2\text{MHz}$	$\pi/4$ DQPSK		-38		$\leq -30$	dB
			8DPSK		-34		$\leq -25$	dB
	$F = F_0 - 2\text{MHz}$	$\pi/4$ DQPSK		-21		$\leq -7$	dB	
		8DPSK		-21		$\leq 0$	dB	

	F = F <sub>0</sub> -3MHz	π/4 DQPSK		-27		≤-20	dB
		8DPSK		-20		≤-13	dB
	F = F <sub>0</sub> +5MHz	π/4 DQPSK		-52		≤-40	dB
		8DPSK		-45		≤-33	dB
	F = F <sub>image</sub>	π/4 DQPSK		-21		≤-7	dB
		8DPSK		-21		≤0	dB

## Audio Codec: ADC (MIC PATH/Line-in path)

Test Condition:

T= 25°C, V<sub>DD</sub>=2.8V, 1KHz sine wave input, Bandwidth = 20~20KHz

Parameter	Condition	Min.	Typ.	Max.	Unit
<b>Input full-scale</b>	Full scale (line-in)			2.2	Vpp
<b>Resolution</b>			16		bits
<b>Input Sampling Rate</b>		8		48	kHz
<b>SNR</b>	f <sub>in</sub> =1KHz B/W=20~20KHz A-weighted THD+N < 1% 150mVpp input	8KHz		85	dB
		16KHz		85	
		32KHz		85	
		44.1KHz		85	
		48KHz		85	
<b>SNR</b>	A-weighted 1KHz@full scale, Microphone boost enable		75		dB
<b>THD+N (Mic input)</b> @30mVrms input			0.04		%
<b>THD+N (line input)</b>			0.01		%
<b>Mic Boost Gain</b>			20		dB
<b>Digital Gain</b>		-54		4.85	dB
<b>Analog Gain</b>				26	dB
<b>Digital Gain Step</b>			6		dB
<b>Analog Gain Step</b>			1.7		dB
<b>Input impedance</b> (microphone mode)	Input impedance		6	10	KΩ
	Input capacitance			20	pF
<b>Analog supply voltage (AVDD)</b>		1.8	2.8	3.0	V

## Audio Codec: DAC (SPEAKER path)

Test Condition: T= 25°C, V <sub>DD</sub> =2.8V, 1KHz sine wave input, Bandwidth= 20~20KHz						
Parameter	Condition		Min.	Typ.	Max.	Unit
Output Level	Full scale			2.1		V <sub>pp</sub>
Resolution			16			bits
Output Sampling Rate			8		48	KHz
SNR	f <sub>in</sub> =1KHz B/W=20~20KHz A-weighted THD+N < 0.01% 0dBFS signal Load=100KΩ	8KHz		94		dB
		16KHz		94		dB
		32KHz		94		dB
		44.1KHz		94		dB
		48KHz		94		dB
Max Output Power	R <sub>L</sub> =16Ohm			35		mW
	R <sub>L</sub> =32Ohm			17		mW
THD+N	16Ohm load				0.05	%
	100KΩ load				0.01	%
Digital Gain			-54		4.85	dB
Digital Gain Resolution				6		dB
Analog Gain			-28		3	dB
Analog Gain step				1		dB
Output resistance	R <sub>L</sub>		8	16		Ohm
Output capacitance	C <sub>p</sub>				500	pF
Crosstalk between channels	L vs. R, measured at -10dBFS@1KHz input			-90	-80	dB
Analog supply voltage (AVDD)			1.8	2.8	3.0	V

## Battery Charger

Charging Mode (BAT_IN rising to 4.2V)		Min	Typ	Max	Unit
Operation Temperature		-10		55	°C
Input Voltage (Vin) Note: It needs more time to get battery fully charged when Vin=4.5V		4.5		7	V
Battery trickle charge current (BAT_IN < trickle charge voltage threshold)			0.1C		mA
Trickle charge voltage threshold			3		V
Maximum battery charge current	Headroom > 0.7V		350		mA
	Headroom = 0.3V		150		mA
Minimum battery charge current	Headroom > 0.7V		1		mA
	Headroom = 0.3V		1		mA
Battery charge termination current, % of fast charge current			10		%
Battery recharge hysteresis (Note1)			100		mV
Battery recharge current (Note2) Note: C → Battery capacity			0.25C		mA

Note1 : When charging complete and the adapter is still in, the battery voltage will slowly drop down.

When the voltage drop is larger than 100mV from the full voltage, the re-charging cycle will start.

Note2 : If the battery voltage during plug in is larger than 4V, the charging current will be limited to 0.25C to avoid the battery voltage overshoot.

## Clock

Parameters	MIN	TYP	MAX	Unit
Crystal Frequency		16		MHz
Frequency Tolerance		±20		ppm
Operating Temperature	-20		70	°C
Trimming Capacitance		6.4		pF
Trimming Step Size		0.2		pF

## Digital GPIO

Parameters	MIN	TYP	MAX	Unit
<b>Input Voltage</b>	2.7	3	3.6	V
V <sub>IH</sub> (Input High Voltage)	2.0		V <sub>dd</sub>	V
V <sub>IL</sub> (Input Low Voltage)	0		0.8	V
<b>Input Reference Resistor</b>				
R <sub>PU</sub> (Pull-Up Resistor)		50K		Ohm
R <sub>PD</sub> (Pull-Down Resistor)		50K		Ohm
<b>Output Voltage</b>				
V <sub>OH</sub> (Output High Voltage)	2.4		V <sub>dd</sub>	V
V <sub>OL</sub> (Output Low Voltage)	0		0.4	V



## Current Consumption ROM mode

Test Condition: T= 25°C, BAT_IN=4.0V, with flash code				
Normal Operation	Min	Typ	Max	Unit
Off mode	2		10	uA
Standby mode		0.6		mA
Link mode		0.6		mA
SCO link		13.7		mA
A2DP link		15.3		mA

## Current Consumption Flash mode

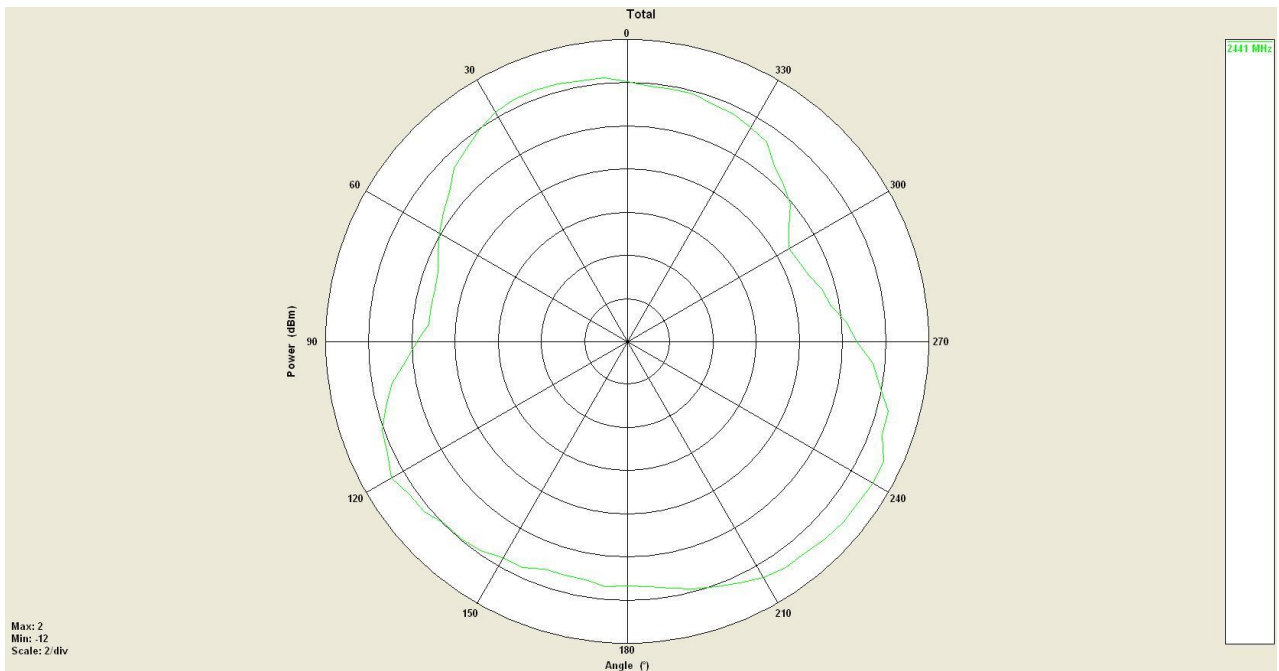
(special code, the number depends on the FW code)

Test Condition: T= 25°C, BAT_IN=4.0V, with flash code, codec without loading				
Normal Operation	Min	Typ	Max	Unit
Off mode	2		10	uA
Standby mode		1.4		mA
Link mode		1.4		mA
SCO link		22.8		mA
A2DP link		24.6		mA

**Antenna performance**

Parameters	MIN	TYP	MAX	Unit
Antenna gain		1.76		dBi
Efficiency	51.5		59.7	%

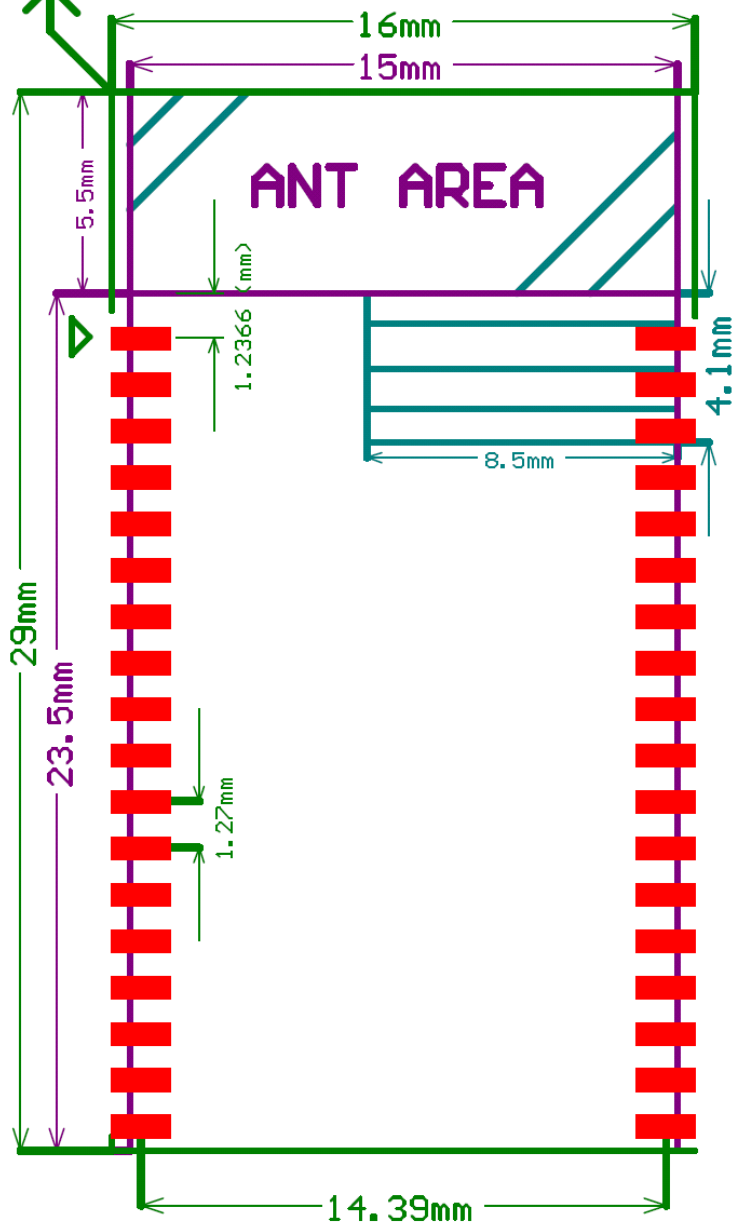
**2441MHz**



Outline Dimension (Module Foot print)

# BM81 Module Footprint

$\langle 0, 0 \rangle$



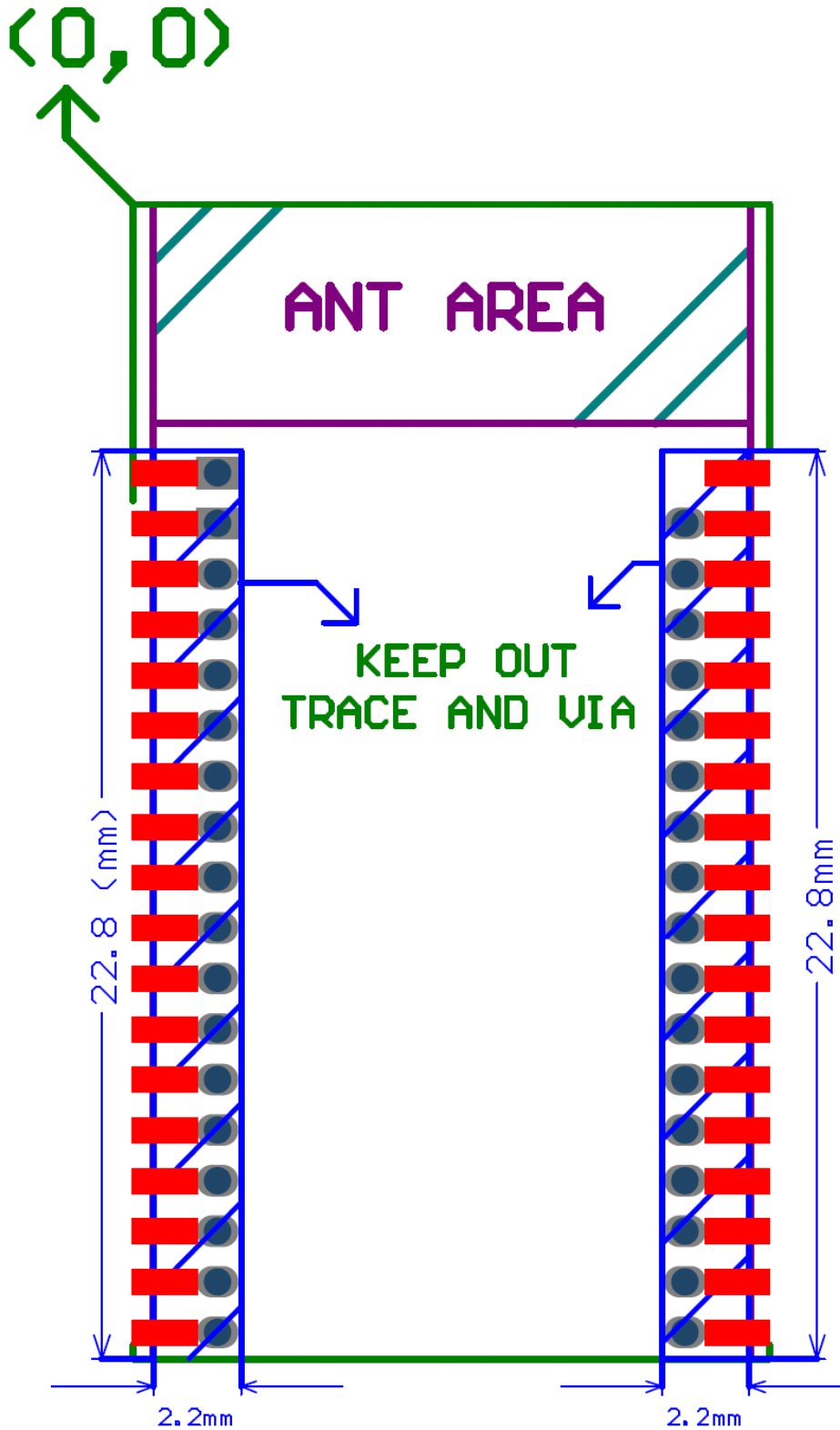
RF TP AREA  
KEEP OUT

Pad Size

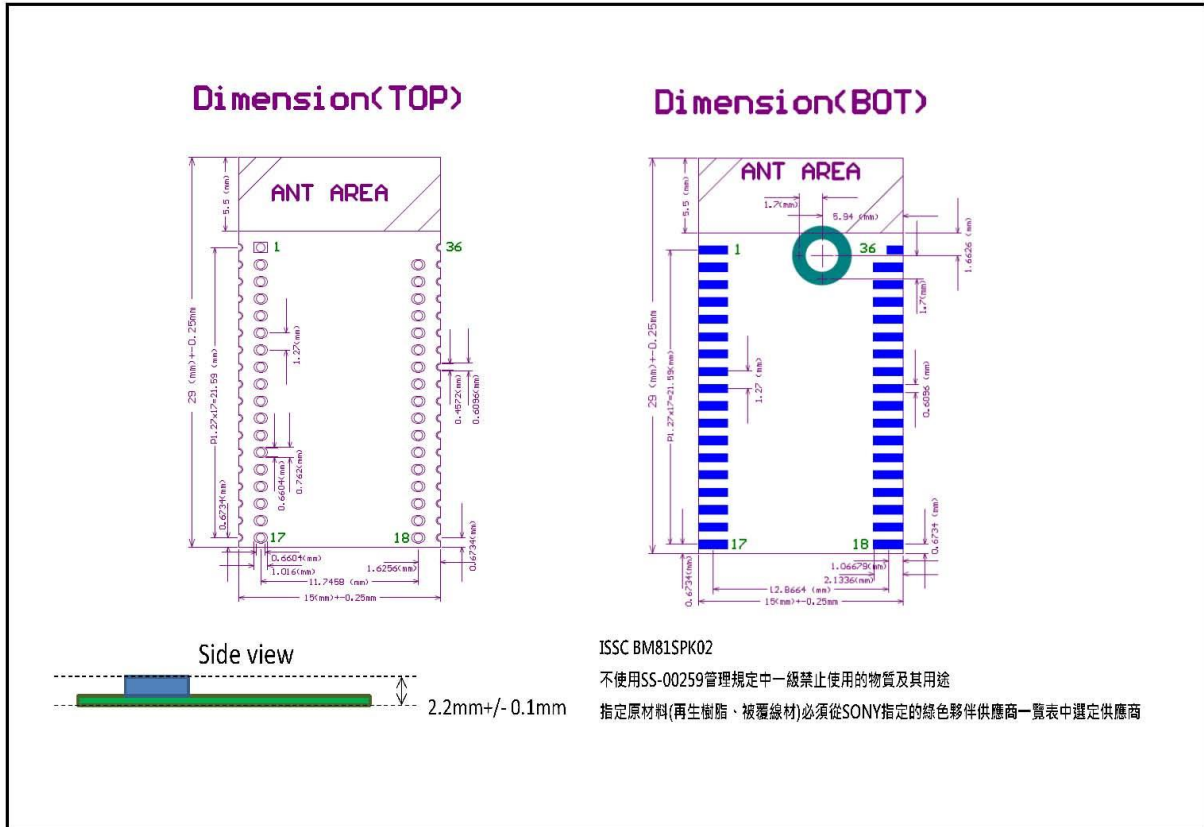


L: 1.61mm / W: 0.6096mm

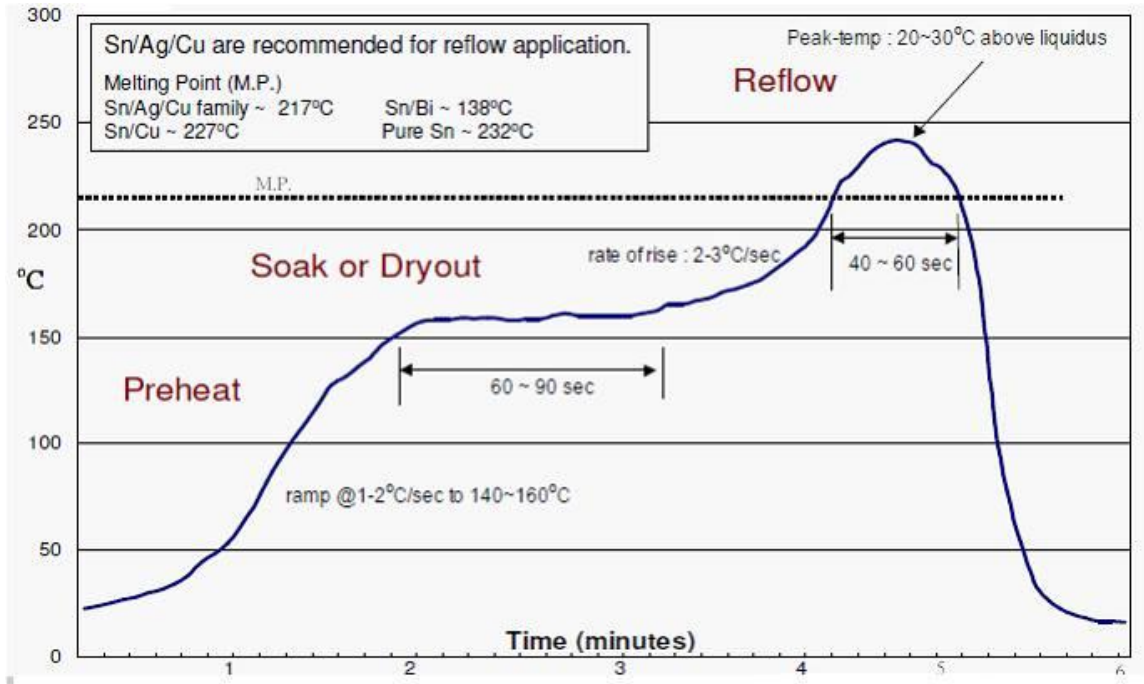
**BM81SPK02 Trace + Via**



**Outline Dimensions**



**Reflow profile**



## QR code label information

Device Name: BM81SPK02NB6

MAC ID: 8CDE52AABBCC

Customer Code Name: C331AA

Date Code: 1312



Label Size:  $15 \pm 1.5 * 6 \pm 1.5$  mm

## Module Weight

(Test condition: module with QR label)

$1.15g \pm 10\%$

Storage standard



**ATTENTION**  
注意

**This Bag Contains**

**ELECTROSTATIC SENSITIVE DEVICES**



1. Shelf life in sealed bag: 12 months at <math>40^{\circ}\text{C}</math> and <math>90\%</math> relative humidity (RH)  
保存期限:12个月,储存环境条件:在温度<math>40^{\circ}\text{C}</math>,相对湿度<math>90\%</math> RH

2. Peak Module body temperature:  $245\pm 5^{\circ}\text{C}$

3. After this bag is opened, Module that will be subject to SMT processing must be: Mounted with 168 hrs at factory conditons of  $\leq 30^{\circ}\text{C}/60\%</math> RH  
拆封后,在工厂环境  $\leq 30^{\circ}\text{C}/60\%</math> RH,模块组件需在 168hrs 内完成 SMT焊接程序$$

SEAL DATE. \_\_\_\_\_  
(If Blank, See Pack Date of Shipping Label)

Version: 1.0

- 24 -

8/20/2013



## Ordering Information

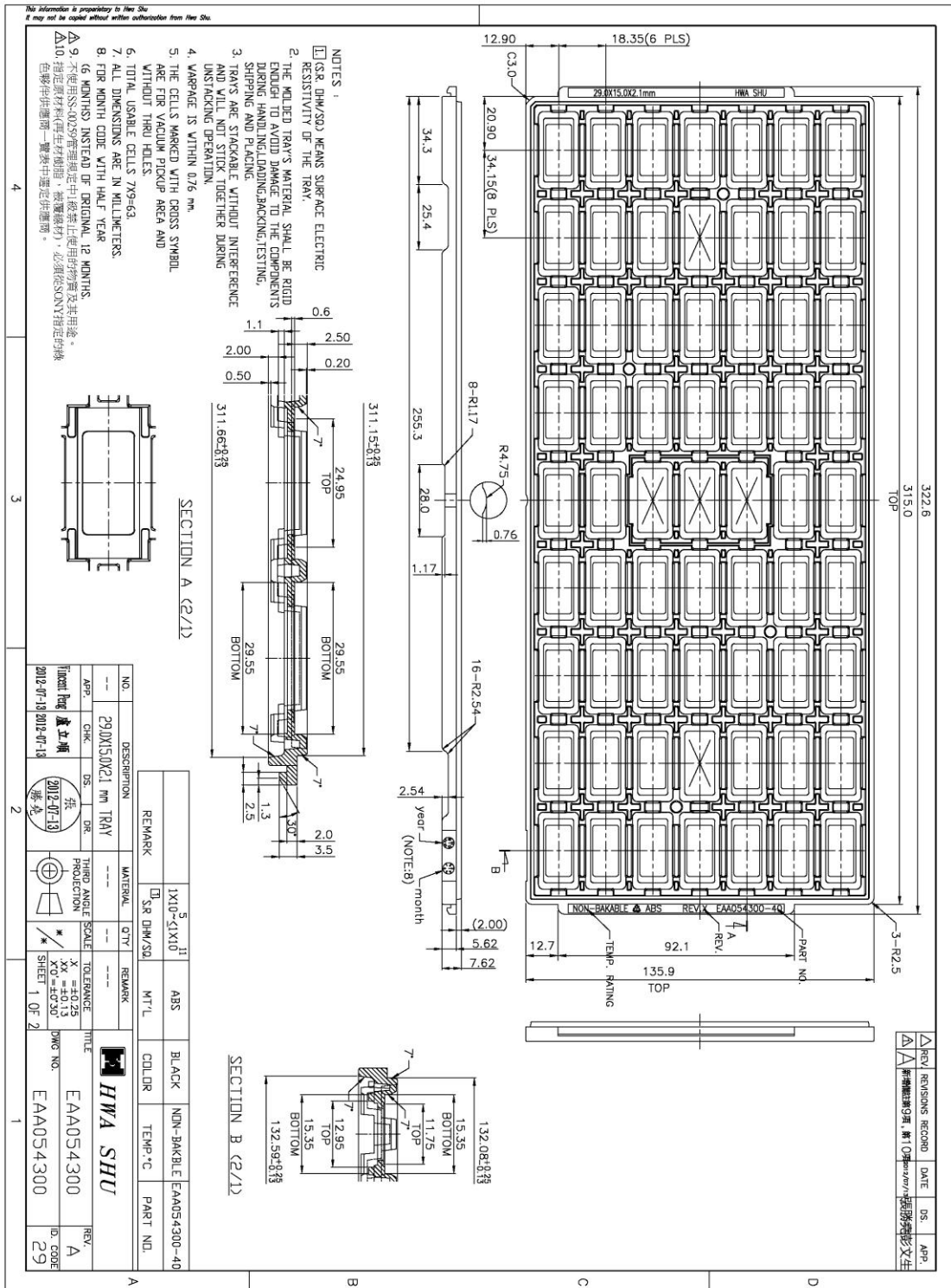
Device	Module		Order Number
	Size	Shipment Method	
<b>BM81SPK02NB6</b> Bluetooth 3.0 EDR Wireless Speaker Module	29*15 mm	Tray	

**Note:**

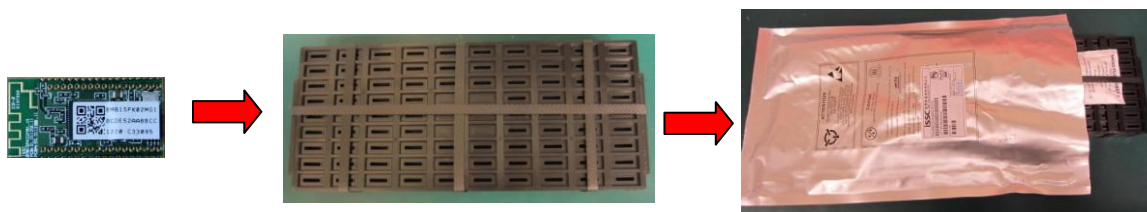
Minimum Order Quantity is 630pcs Tray.

## Packing Information

### Tray Dimensions



Packing Method



Inner box: Q'ty (630 Pcs)  
Dimensions: 36\*16\*9.5 cm

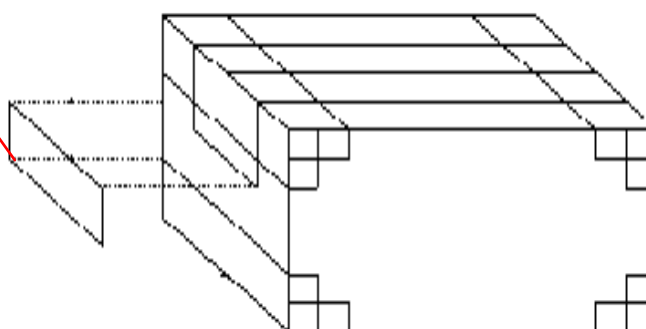


Bar Code Label

P/N: device name

Lot No: Lot ID

Q'ty: box or Carton Module's Q'ty



Carton: Q'ty (3780 Pcs)  
Dimensions: 38\*35\*30 cm